

LM137QML 3-Terminal Adjustable Negative Regulators

Check for Samples: LM137QML

FEATURES

- Output voltage adjustable from -37V to -1.2V
- 1.5A output current guaranteed, -55°C to +150°C
- Line regulation typically 0.01%/V
- Load regulation typically 0.3%
- Excellent thermal regulation, 0.002%/W
- 77 dB ripple rejection
- **Excellent rejection of thermal transients**
- 50 ppm/°C temperature coefficient
- Temperature-independent current limit
- Internal thermal overload protection

- Standard 3-lead transistor package
- Output is short circuit protected

Table 1. LM137 Series Packages and Power Capability

Device	Package	Rated Power Dissipation	Design Load Current
LM137	TO-3 (K)	20W	1.5A
LIVITS7	TO-39 (H)	2W	0.5A

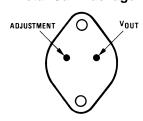
DESCRIPTION

The LM137 are adjustable 3-terminal negative voltage regulators capable of supplying in excess of −1.5A over an output voltage range of -37V to -1.2V. These regulators are exceptionally easy to apply, requiring only 2 external resistors to set the output voltage and 1 output capacitor for frequency compensation. The circuit design has been optimized for excellent regulation and low thermal transients. Further, the LM137 series features internal current limiting, thermal shutdown and safe-area compensation, making them virtually blowout-proof against overloads.

The LM137 serve a wide variety of applications including local on-card regulation, programmable-output voltage regulation or precision current regulation. The LM137 are ideal complements to the LM117 adjustable positive regulators.

Connection Diagram

TO-3 Metal Can Package



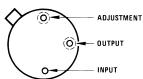
NOTE: Case is Input

Figure 1. Bottom View

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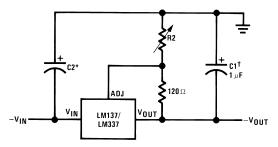
TO-39 Metal Can Package



NOTE: Case Is Input

Figure 2. Bottom View

Typical Applications



Full output current not available at high input-output voltages

$$-V_{OUT} = \, -1.25V \left(1 + \frac{R2}{120}\right) + \left(-I_{ADJ} \times R2\right)$$

†C1 = 1 μ F solid tantalum or 10 μ F aluminum electrolytic required for stability

*C2 = 1 µF solid tantalum is required only if regulator is more than 4" from power-supply filter capacitor

Output capacitors in the range of 1µF to 1000 µF of aluminum or tantalum electrolytic are commonly used to provide improved output impedance and rejection of transients

Figure 3. Adjustable Negative Voltage Regulator



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings (1)

Power Dissipation (2)	Internally Limited
Input-Output Voltage Differential	40V
Operating Ambient Temperature Range	-55°C ≤ T _A ≤ +125°C
Operating Junction Temperature Range	-55°C ≤ T _J ≤ +150°C
Storage Temperature	-65°C ≤ T _A ≤ +150°C
Maximum Junction Temperature	150°C
Lead Temperature (Soldering, 10 sec.)	300°C
Minimum Input Voltage	-41.25V
Maximum Power Dissipation (@25°C)	
T0-3	28 Watts
T0-39	2.5 Watts
Thermal Resistance	
θ_{JA}	
T0-3 Metal Can (Still Air)	40°C/W
T0-3 Metal Can (500LF/Min Air Flow)	14°C/W
T0-39 Metal Can (Still Air @ 0.5W)	174°C/W
T0-39 Metal Can (500LF/Min Air Flow @ 0.5W)	64°C/W
θ _{JC}	
T0-3	4°C/W
T0-39 Metal Can (@ 1.0W)	15°C/W
Package Weight (typical)	
T0-3	12,750mg
T0-39 Metal Can	955mg
ESD Rating (3)	4000V

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower. Human body model, 100pF discharged through 1.5K Ω

Recommended Operating Conditions

TA	-55°C ≤ T _A ≤ +125°C
Input Voltage Range	-41.25V to -4.25V

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Quality Conformance Inspection

Table 2. Mil-Std-883, Method 5005 — Group A⁽¹⁾

Subgroup	Description	Temp (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

⁽¹⁾ Group "A" sample only, test at all temps.



LM137H 883 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. $V_{IN} = -4.25V$, $I_L = 8mA$, $V_{OUT} = V_{Ref}^{(1)(2)}$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
				-1.275	-1.225	V	1
\ <i>I</i>	Defense of Veltage			-1.3	-1.2	V	2, 3
V_{Ref}	Reference Voltage	V _{IN} = -42V		-1.275	-1.225	V	1
		V _{IN} = -41.3V		-1.3	-1.2	V	2, 3
		V _{OUT} = -1.7V			3.0	mA	1, 2, 3
	Minimum I and Comment	V _{OUT} = -1.7V, V _{IN} = -11.75V			3.0	mA	1, 2, 3
I_Q	Minimum Load Current	$V_{OUT} = -1.7V, V_{IN} = -42V$			5.0	mA	1
		$V_{OUT} = -1.7V, V_{IN} = -41.3V$			5.0	mA	2, 3
D	Line Decidation	-42V ≤ V _{IN} ≤ -4.25V		-9.0	9.0	mV	1
R _{Line}	Line Regulation	$-41.3V \le V_{IN} \le -4.25V$		-23	23	mV	2, 3
		5mA ≤ I _L ≤ 500mA, V _{IN} = -6.25V		-25	25	mV	1, 2, 3
R _{Load}	Load Regulation	5mA ≤ I _L ≤ 500mA, V _{IN} = -14.5V		-25	25	mV	1
		5mA ≤ I _L ≤ 150mA, V _{IN} = -40V		-25	25	mV	1, 2, 3
		I _L = 5 mA			100	μΑ	1, 2, 3
I_{Adj}	Adjustment Pin Current	V _{IN} = -42V			100	μΑ	1
		V _{IN} = -41.3V			100	μΑ	2, 3
A.I. /\/	Adjust Pin Current Change vs.	$-42V \le V_{IN} \le -4.25V$, $I_L = 5 \text{ mA}$		-5.0	5.0	μΑ	1
Δ I _{Adj} / V _{Line}	Line Voltage	$-41.3V \le V_{IN} \le -4.25V$, $I_L = 5 \text{ mA}$		-5.0	5.0	μΑ	2, 3
Δ I _{Adj} / I _{Load}	Adjust Pin Current Change vs. Load Current	5 mA ≤ I _L ≤ 500 mA, V _{IN} = -6.5V		-5.0	5.0	μΑ	1, 2, 3
0	The second December 2	V _{IN} = -14.5V, I _L = 500mA, t = 10mS		-5.0	5.0	mV	1
θ_{R}	Thermal Regulation	$V_{IN} = -14.5V, I_{L} = 5mA, t = 10mS$		-5.0	5.0	mV	1
θ_{JC}	Thermal Resistance		(3)		15	°C/W	1
	Current Limit	V _{IN} = -5V		-1.8	-0.5	Α	1, 2, 3
I _{CL}	Current Limit	V _{IN} = -40V		-0.65	-0.15	Α	1, 2, 3
\/	Output Valtage			-1.28	-1.22	V	1
Vo	Output Voltage			-1.3	-1.2	V	2, 3

⁽¹⁾ $V_{IN} = -41.3V$ at $+125^{\circ}C$ and $-55^{\circ}C$

LM137H 883 Electrical Characteristics AC Parameters

R _R	Ripple Rejection Ratio	$V_{IN} = -6.25V, V_{OUT} = V_{Ref}, \ I_{L} = 125mA, e_{I} = 1V_{RMS}, \ F = 120Hz$	(1)(2)(1)	66		dB	4, 5, 6
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⁽¹⁾ Bench test, refer to (SG)RPI-3-362.

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⁽²⁾ $-41.3V \le V_{IN} \le -4.25V$ at $+125^{\circ}$ C and -55° C

⁽³⁾ Guaranteed parameter, not tested.

⁽²⁾ Test at +25°C, guaranteed but not tested at +125°C and -55°C



LM137K 883 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. $V_{IN} = -4.25V$, $I_L = 8mA$, $V_{OUT} = V_{Ref}^{(1)(2)}$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
				-1.275	-1.225	V	1
\ /	Deference Veltore			-1.3	-1.2	V	2, 3
V_{Ref}	Reference Voltage	V _{IN} = -42V		-1.275	-1.225	V	1
		V _{IN} = -41.3V		-1.3	-1.2	V	2, 3
		V _{OUT} = -1.7V			3.0	mA	1, 2, 3
	Minimum I and Command	V _{OUT} = -1.7V, V _{IN} = -11.75V			3.0	mA	1, 2, 3
I _Q	Minimum Load Current	V _{OUT} = -1.7V, V _{IN} = -42V			5.0	mA	1
		V _{OUT} = -1.7V, V _{IN} = -41.3V			5.0	mA	2, 3
Б	Line Demokrine	-42V ≤ V _{IN} ≤ -4.25V		-9.0	9.0	mV	1
R _{Line}	Line Regulation	-41.3V ≤ V _{IN} ≤ -4.25V		-23	23	mV	2, 3
	Load Regulation	V _{IN} = -6.25V, 8mA ≤ I _L ≤ 1.5A		-25	25	mV	1, 2, 3
Б		V _{IN} = -14.5V, 8mA ≤ I _L ≤ 1.5A		-25	25	mV	1
R _{Load}		$V_{IN} = -40V$, $8mA \le I_L \le 300 \text{ mA}$		-25	25	mV	1
		V _{IN} = -40V, 8mA ≤ I _L ≤ 250 mA		-25	25	mV	2, 3
					100	μA	1, 2, 3
I_{Adi}	Adjustment Pin Current	V _{IN} = -42V			100	μA	1
,		V _{IN} = -41.3V			100	μA	2, 3
Δ I _{Adj} / V _{Line}	Adjust Pin Current Change vs.	-42V ≤ V _{IN} ≤ -4.25V		-5.0	5.0	μA	1
	Line Voltage	-41.3V ≤ V _{IN} ≤ -4.25V		-5.0	5.0	μA	2, 3
Δ I _{Adj} / I _{Load}	Adjust Pin Current Change vs. Load Current	$8 \text{ mA} \le I_L \le 1.5 \text{A}, V_{IN} = -6.25 \text{V}$		-5.0	5.0	μΑ	1, 2, 3
V_{Rth}	Thermal Regulation	V _{IN} = -14.5V, I _L = 1.5mA, t = 10mS		-5.0	5.0	mV	1
Kui		$V_{IN} = -14.5V$, $I_L = 8mA$, $t = 10mS$		-5.0	5.0	mV	1
θ_{JC}	Thermal Resistance		(3)		4.0	°C/W	1
	Ourse of Library	V _{IN} = -5V		-3.5	-1.5	Α	1, 2, 3
I _{CL}	Current Limit	V _{IN} = -40V		-1.2	-0.24	Α	1, 2, 3

LM137K 883 Electrical Characteristics AC Parameters

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
R _R	Ripple Rejection Ratio	$V_{IN} = -6.25V$, $V_{OUT} = V_{Ref}$, $f = 120Hz$, $I_{L} = 0.5A$, $e_{I} = 1V_{RMS}$	(1)(2)(1)	66		dB	4, 5, 6

⁽¹⁾ Bench test, refer to (SG)RPI-3-362.

⁽¹⁾ $V_{IN} = -41.3V$ at +125°C and -55°C (2) $-41.3V \le V_{IN} \le -4.25V$ at +125°C and -55°C

Guaranteed parameter, not tested.

⁽²⁾ Test at +25°C, guaranteed but not tested at +125°C and -55°C



LM137H RH Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. (1)

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
		V 4.05V 1 5 A		-1.275	-1.225	V	1
		$V_{IN} = -4.25V, I_{L} = 5mA$		-1.3	-1.2	V	2, 3
				-1.275	-1.225	V	1
		$V_{IN} = -4.25V, I_L = 500mA$		-1.3	-1.2	V	2, 3
V_{OUT}	Output Voltage	V 44.05V I 5 A		-1.275	-1.225	V	1
		$V_{IN} = -41.25V, I_L = 5mA$		-1.3	-1.2	V	2, 3
		V 44.05V I 50 v A		-1.275	-1.225	V	1
		$V_{IN} = -41.25V, I_L = 50mA$		-1.3	-1.2	V	2, 3
.,	Line Degulation	$V_{IN} = -41.25V \text{ to } -4.25V,$		-9.0	9.0	mV	1
$V_{R Line}$	Line Regulation	$I_L = 5mA$		-23	23	mV	2, 3
				-12	12	mV	1
		$V_{IN} = -6.25V$, $I_L = 5mA$ to 500mA		-24	24	mV	2, 3
.,		., ., ., .,		-6.0	6.0	mV	1
$V_{R Load}$	V _{R Load} Load Regulation	$V_{IN} = -41.25V$, $I_L = 5mA$ to $50mA$		-12	12	mV	2, 3
		$V_{IN} = -6.25V$, $I_L = 5mA$ to 200mA		-6.0	6.0	mV	1
				-12	12	mV	2, 3
V_{Rth}	Thermal Regulation	V _{IN} = -14.6V, I _L = 500mA		-5.0	5.0	mV	1
	A.E. 4.B. 0	V _{IN} = -4.25V, I _L = 5mA		25	100	μA	1, 2, 3
I _{Adj}	Adjust Pin Current	V _{IN} = -41.25V, I _L = 5mA		25	100	μA	1, 2, 3
Δ I _{Adj} / V _{Line}	Adjust Pin Current Change vs. Line Voltage	V _{IN} = -41.25V to -4.25V, I _L = 5mA		-5.0	5.0	μΑ	1, 2, 3
Δ I _{Adj} / I _{Load}	Adjust Pin Current Change vs. Load Current	V _{IN} = -6.25V, I _L = 5mA to 500mA		-5.0	5.0	μΑ	1, 2, 3
	Output Chart Circuit Current	$V_{IN} = -4.25V$		0.5	1.8	Α	1, 2, 3
los	Output Short Circuit Current	V _{IN} = -40V		0.05	0.5	Α	1, 2, 3
		1.051/		-1.275	-1.225	V	1
V_{OUT}	Output Voltage Recovery After	V _{IN} = -4.25V		-1.3	-1.2	V	2, 3
Recovery	Output Short Circuit Current	101		-1.275	-1.225	V	1
		V _{IN} = -40V		-1.3	-1.2	V	2, 3
		V _{IN} = -4.25V		0.2	3.0	mA	1, 2, 3
I_Q	Minimum Load Current	V _{IN} = -14.25V		0.2	3.0	mA	1, 2, 3
		V _{IN} = -41.25V		1.0	5.0	mA	1, 2, 3
W	Valta na Otant ur	V 4.05V I 500 A		-1.275	-1.225	V	1
V_{Start}	Voltage Start-up	$V_{IN} = -4.25V, I_L = 500mA$		-1.3	-1.2	V	2, 3
V _{OUT}	Output Voltage	$V_{IN} = -6.25V, I_L = 5mA$	(2)	-1.3	-1.2	V	2

⁽¹⁾ Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

⁽²⁾ Tested at +125°C; correlated to +150°C



LM137H RH Electrical Characteristics AC Parameters

The following conditions apply, unless otherwise specified.

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
ΔV _{IN} / ΔV _{OUT}	Ripple Rejection	$V_{IN} = -6.25V$, $I_L = 125mA$, $e_I = 1V_{RMS}$ at 2400Hz		48		dB	9
V _{NO}	Output Noise Voltage	$V_{IN} = -6.25V, I_L = 50mA$			120	μV_{RMS}	9
ΔV _{OUT} / ΔV _{IN}	Line Transient Response	$V_{IN} = -6.25V, V_{Pulse} = -1V, I_{L} = 50mA$			80	mV/V	9
ΔV_{O} / ΔI_{L}	Load Transient Response	$V_{IN} = -6.25V, I_L = 50mA, $ $\Delta I_L = 200mA$	(2)		60	mV	9

⁽¹⁾ Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

LM137H RH Electrical Characteristics DC Parameters Drift Values

The following conditions apply, unless otherwise specified.

Delta calculations performed on QMLV devices at group B, subgroup 5 only.

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
		$V_{IN} = -4.25V, I_{L} = 5mA$		-0.01	0.01	V	1
V	Output Valtage	$V_{IN} = -4.25V, I_{L} = 500mA$		-0.01	0.01	V	1
V _{OUT}	Output Voltage	$V_{IN} = -41.25V, I_L = 5mA$		-0.01	0.01	V	1
		$V_{IN} = -41.25V, I_L = 50mA$		-0.01	0.01	V	1
V _{R Line}	Line Regulation	$V_{IN} = -41.25V$ to $-4.25V$, $I_L = 5mA$		-4.0	4.0	mV	1
	Adjust Din Current	$V_{IN} = -4.25V, I_{L} = 5mA$		-10	10	μΑ	1
I _{Adj}	Adjust Pin Current	$V_{IN} = -41.25V, I_L = 5mA$		-10	10	μΑ	1

⁽¹⁾ Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

⁽²⁾ Limit of 0.3mV/mA is equivalent to 60mV



LM137H RH Electrical Characteristics DC Parameters Post Radiation Limits +25°C 5962P9951701VXA

The following conditions apply, unless otherwise specified.

(1)

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
Δ I _{Adj} / V _{Line}	Adjust Pin Current Change vs. Line Voltage	$V_{IN} = -41.25V$ to -4.25V, $I_L = 5$ mA		-20	20	μΑ	1

⁽¹⁾ Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

LM137H RH Electrical Characteristics DC Parameters Post Radiation Limits +25°C 5962P9951708VXA

The following conditions apply, unless otherwise specified.

(1)

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub- groups
V _{OUT}	Output Voltage	$V_{IN} = -41.25V, I_L = 5mA$		-1.30	-1.225	٧	1
		$V_{IN} = -41.25V, I_L = 50mA$		-1.30	-1.225	٧	1
V _{R Line}	Line Regulation	$V_{IN} = -41.25V$ to -4.25V, $I_L = 5$ mA		-9.0	+50	mV	1
I_{Adj}	Adjust Pin Current	$V_{IN} = -41.25V, I_L = 5mA$		25	140	μΑ	1
Δ I _{Adj} / V _{Line}	Adjust Pin Current Change vs. Line Voltage	$V_{IN} = -41.25V$ to -4.25V, $I_L = 5$ mA		-70	+20	μΑ	1
V _{OUT} Recovery	Output Voltage Recovery After Output Short Circuit Current	V _{IN} = -4.25V		-1.30	-1.225	V	1

(1) Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics except as listed in the Post Radiation Limits Table. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are guaranteed only for the conditions as specified in Mil-Std-883, Method 1019.5, Condition A.

Product Folder Links: LM137QML



APPLICATION INFORMATION

Schematic Diagram

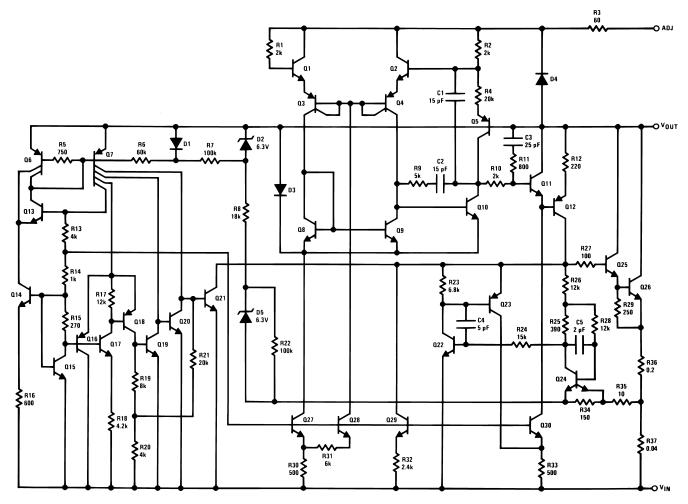
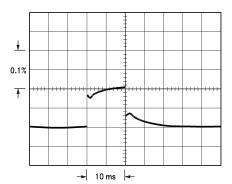


Figure 4. Schematic Diagram

Thermal Regulation

When power is dissipated in an IC, a temperature gradient occurs across the IC chip affecting the individual IC circuit components. With an IC regulator, this gradient can be especially severe since power dissipation is large. Thermal regulation is the effect of these temperature gradients on output voltage (in percentage output change) per Watt of power change in a specified time. Thermal regulation error is independent of electrical regulation or temperature coefficient, and occurs within 5 ms to 50 ms after a change in power dissipation. Thermal regulation depends on IC layout as well as electrical design. The thermal regulation of a voltage regulator is defined as the percentage change of V_{OUT}, per Watt, within the first 10 ms after a step of power is applied. The LM137's specification is 0.02%/W, max.

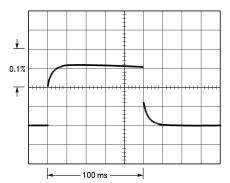




$$\begin{split} LM137, \ V_{OUT} &= -10V \\ V_{IN} - V_{OUT} &= -40V \\ I_{IL} &= 0A \rightarrow 0.25A \rightarrow 0A \\ Vertical \ sensitivity, \ 5 \ mV/div \end{split}$$

Figure 5.

In Figure 5, a typical LM137's output drifts only 3 mV (or 0.03% of $V_{OUT} = -10V$) when a 10W pulse is applied for 10 ms. This performance is thus well inside the specification limit of $0.02\%/W \times 10W = 0.2\%$ max. When the 10W pulse is ended, the thermal regulation again shows a 3 mV step as the LM137 chip cools off. Note that the load regulation error of about 8 mV (0.08%) is additional to the thermal regulation error. In Figure 6, when the 10W pulse is applied for 100 ms, the output drifts only slightly beyond the drift in the first 10 ms, and the thermal error stays well within 0.1% (10 mV).

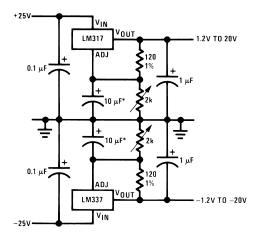


LM137, V_{OUT} = -10V V_{IN} - V_{OUT} = -40V I_L = 0A \rightarrow 0.25A \rightarrow 0A Horizontal sensitivity, 20 ms/div

Figure 6.



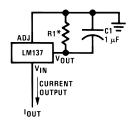
Typical Applications



Full output current not available at high input-output voltages

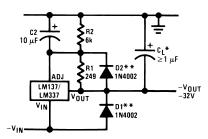
*The 10 μF capacitors are optional to improve ripple rejection

Figure 7. Adjustable Lab Voltage Regulator



 $I_{OUT} = \frac{1.250V}{R1}$ $^*0.8\Omega \le R1 \le 120\Omega$

Figure 8. Current Regulator

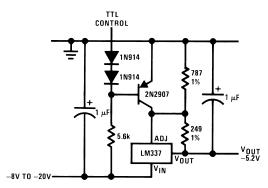


*When C_L is larger than 20 µF, D1 protects the LM137 in case the input supply is shorted

Figure 9. Negative Regulator with Protection Diodes

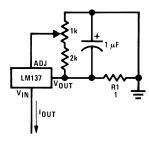
^{**}When C2 is larger than 10 μ F and $-V_{OUT}$ is larger than -25V, D2 protects the LM137 in case the output is shorted





*Minimum output \simeq -1.3V when control input is low

Figure 10. -5.2V Regulator with Electronic Shutdown*



 $I_{OUT} = \left(\frac{1.5V}{R1}\right) \pm 15\%$ adjustable

Figure 11. Adjustable Current Regulator

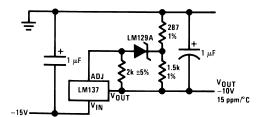
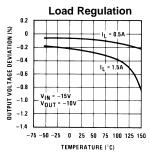


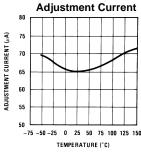
Figure 12. High Stability -10V Regulator

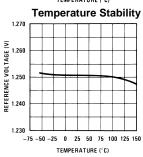


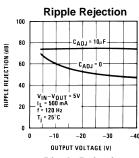
Typical Performance Characteristics

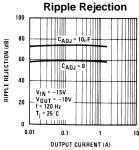
(H & K Packages)

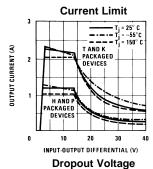


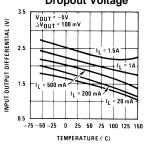


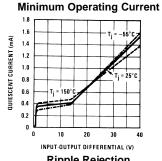


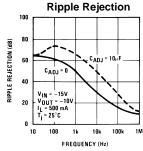


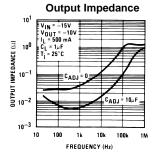








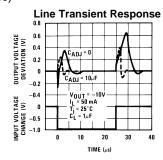


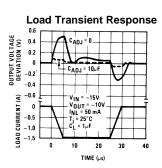




Typical Performance Characteristics (continued)

(H & K Packages)





REVISION HISTORY

Date Released	Revision	Section	Changes
12/08/2010	А	New Release, Corporate format	3 MDS data sheets converted into one Corp. data sheet format. MNLM137-X, Rev. 0B1, MNLM137-K Rev. 0A0, and MRLM137–X-RH Rev. 2A0. MDS data sheets will be archived.
03/16/2012	В	Ordering Information, LM137K 883 Electrical Characteristics DC Parameters., LM137H RH Electrical Characteristics DC Parameters., DC Parameters Post Radiation Limits +25 Deg. C for 701VXA., DC Parameters Post Radiation Limits +25 Deg. C for 708VXA	Ordering Info — Added new LM137H1PQMLV., For the DC Parameters of LM137K 883 and LM137 RH, widened columns to accommodate correct limits. Added to the HEADER of DC Parameters — Post Radiation Limits 5962P9951701VXA. Added the HEADER and TABLE of DC Parameters — Post Radiation Limits 5962P9951708VXA. Rev A will be archived.

Product Folder Links: LM137QML



17-Nov-2012

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Samples
	(1)		Drawing			(2)		(3)	(Requires Login)
LM137H/883	ACTIVE	ТО	NDT	3	20	TBD	POST-PLATE	Level-1-NA-UNLIM	
LM137K/883	ACTIVE	ТО	K	2	50	TBD	POST-PLATE	Level-1-NA-UNLIM	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used betwee the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF LM137QML, LM137QML-SP:

Military: LM137QML

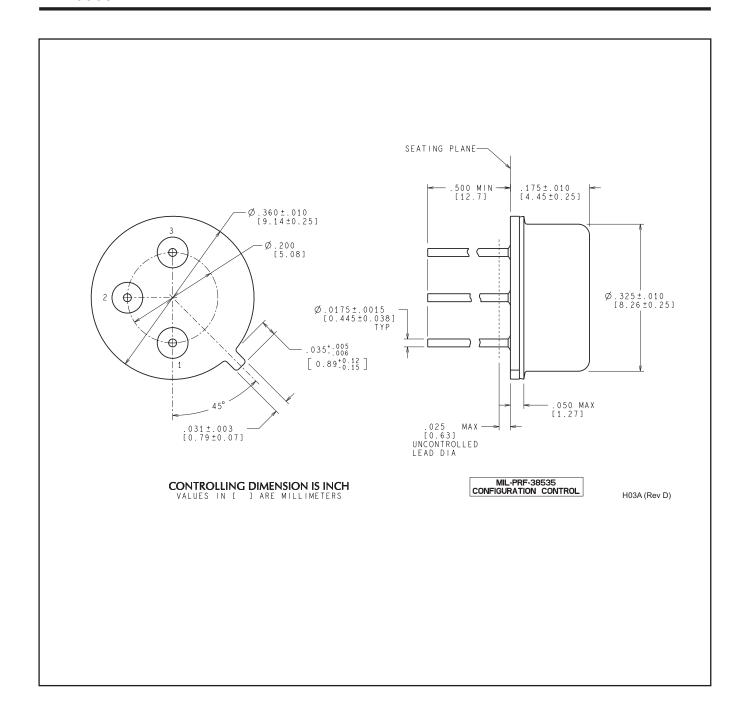
Space: LM137QML-SP

NOTE: Qualified Version Definitions:

PACKAGE OPTION ADDENDUM

17-Nov-2012

- Military QML certified for Military and Defense Applications
- Space Radiation tolerant, ceramic packaging and qualified for use in Space-based application



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